

Technical Information

6120 Silver Conductor Paste

The 6120 silver paste was developed for high density microcircuit applications on alumina or dielectric. Its fine line capability and compatibility with dielectrics make it suitable for inner as well as top layer metallization for multilayer circuitry. For a platable version or RF/Microwave applications please see KOARTAN 6111. The 6120 does not contain cadmium, lead,

nickel, or highly toxic organic solvents. Key features include:

- RoHS Compliant
- High Conductivity
- Good Line Resolution
- High Speed Printing
- Compatibility with Dielectrics and Resistors

TYPICAL FIRED FILM CHARACTERISTICS⁽¹⁾

Fired Thickness	12-16 μm
Line Resolution	175/125 μm line/space using 150/150 μm pattern and 325 mesh screen
Resistivity	≤ 2.50 milliohm/square at 12 μm fired thickness
Solder Acceptance⁽²⁾ 36/62/2 Sn/Pb/Ag, on 96% alumina	Excellent
Solder Leach Resistance⁽³⁾	2-3 Cycles
Adhesion⁽⁴⁾	
Initial	> 22 N
500 Hours @ 150°C	> 18 N

- (1) Typical properties are based on testing of several batches under various processing conditions. They are not intended as specification limits.
- (2) Excellent refers to nearly 100% coverage of both pads and lines after a 5-second dip in the solder bath at 225°C +/- 5°C using Alpha 611 mildly activated flux, 96% alumina substrate.
- (3) Cycles consist of 10-second dips in a 225°C +/- 5°C solder bath. Each cycle is preceded by dipping in Alpha 611 flux.
- (4) The adhesion test consists of attaching 20 AWG tinned copper wire to 2mmx2mm pads, by dipping in 225°C +/- 5°C solder for 5 seconds. The wires are then bent 90 degrees and pulled at constant speed, while a force gauge records the peel strength.

COMPOSITION PROPERTIES

Viscosity: 120 ± 30 Kcps, when measured with Brookfield HBT viscometer, Spindle #14, utility cup, 10 rpm, 25°C

Specific Gravity: 3.8 – 4.2 g/cm³

Recommended Thinner: KOARTAN A-1039

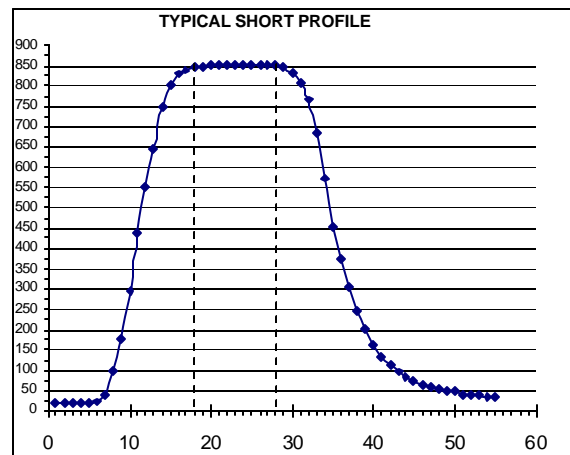
RECOMMENDED PROCESSING PROCEDURE

Printing: Printing with 280 mesh stainless steel screen using 10-15 μm emulsion and 45 degree angle is recommended. Other mesh counts, 200-325, and emulsion thicknesses, 5-25 μm , may be used for special applications. Squeegee speeds of up to 10 inches/sec may be utilized.

Coverage is approximately 60 cm²/g when utilizing 325 mesh screen and a wet print thickness of about 38 μm .

Drying: Wet prints should be allowed to level for 5-10 minutes prior to drying. Dry for 10-15 minutes in a convection oven or belt dryer at 125°C-150°C.

Firing: Firing in air using a belt furnace and a 36-60 minute profile, with 10 minutes at a peak temperature of 850°C is recommended. Air flow rates must be optimized to ensure that the products of binder burn-off discharge properly and create a fully oxidizing atmosphere in the muffle.



Temperature (°C) vs. Time (minutes)

Storage and Shelf Life: Store in tightly capped containers at room temperature. Shelf life is 6 months for unopened jars. Under ordinary conditions of storage and use the product should not require thinning. However, solvent lost during extended printing runs may be replaced by incorporating up to 0.5% of Koartan A-1039 thinner.

The information presented herein is based on data believed to be dependable and is accurate and reliable to the best of our knowledge and belief, but not guaranteed to be so. Koartan Company assumes no liability arising from the use of this product or the information provided herein. It is the responsibility of the user to verify the information and to establish the suitability of the product(s) for any particular application. Nothing herein is to be construed as recommending any practice or any product in violation of any patent or in violation of any law or regulation.